

Product data sheet

1. General description

Planar passivated four quadrant triac in a IITO3P package intended for use in circuits where high static and dynamic dV/dt and high dl/dt can occur. This triac will commutate the full RMS current at the maximum rated junction temperature ($T_{j(max)} = 150$ °C). It is used in applications where "high junction operating temperature capability" is required.

2. Features and benefits

- High current TRIAC
- Low thermal resistance
- High junction operating temperature capability (T_{i(max)} = 150 °C)
- High voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Insulated tab rated at 2500 V rms

3. Applications

- High current / high surge applications
- High power / industrial controls -- e.g. heating, motors, lighting

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values	Unit				
Absolute	Absolute maximum rating							
V_{DRM}	repetitive peak off-state voltage		600	V				
$I_{T(RMS)}$	RMS on-state current	full sine wave; T _{mb} ≤ 105 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	40	A				
I _{TSM}	non-repetitive peak on- state current	full sine wave; t _p = 20 ms; T _{j(init)} = 25 °C; <u>Fig. 4; Fig. 5</u>	400	A				
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C	440	А				
Tj	junction temperature		150	°C				

BTA41-600B

4Q Triac

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T2+ G+ T _j = 25 °C; <u>Fig. 7</u>	-	-	50	mA
		V_{D} = 12 V; I _T = 0.1 A; T2+ G- T _j = 25 °C; <u>Fig. 7</u>	-	-	50	mA
		V_{D} = 12 V; I _T = 0.1 A; T2- G- T _j = 25 °C; <u>Fig. 7</u>	-	-	50	mA
		V_{D} = 12 V; I _T = 0.1 A; T2- G+ T _j = 25 °C; <u>Fig. 7</u>	-	-	70	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	80	mA
V _T	on-state voltage	I _T = 56.6 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.2	1.5	V
Dynamic	characteristics					
dV _D /dt rate of rise of off-sta voltage		V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	750	-	-	V/µs
		$V_{DM} = 536 \text{ V}; \text{ T}_{\text{j}} = 150 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit$	500	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 20\text{ A}; $ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	20	-	-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 150 \text{ °C}; \text{ I}_{T(RMS)} = 20\text{ A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	10	-	-	A/ms

5. Pinning information

Table 2. P	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	T1	main terminal 1	\bigcirc	T2-T1				
2	T2	main terminal 2		Sym051				
3	G	gate		Symoor				
mb	n.c.	mounting base; isolated	IITO3P (SOT1292)					

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BTA41-600B	IITO3P	BTA41-600BQ	Tube	30	SOT1292	21-Jul-2017

7. Marking

Table 4. Marking codes			
Type number		Marking codes	
BTA41-600B		BTA41-600B	
BTA41-600B	All information provided in this documer	nt is subject to legal disclaimers.	[©] WeEn Semiconductors Co., Ltd. 2019. All rights reserved
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8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V _{DRM}	repetitive peak off-state voltage		600	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 105°C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u>	40	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; $t_p = 20 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$; Fig. 4; Fig. 5	400	A
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C	440	А
l ² t	l ² t for fusing	t _p = 10ms; sine wave	800	A²/s
dl _⊤ /dt	rate of rise of on-state current	I _G = 150mA	150	A/µs
I _{GM}	peak gate current	t _p = 20µs	8	А
P _{GM}	peak gate power	t _p = 20µs	40	W
P _{G(AV)}	average gate power	over any 20 ms period	1	W
T _{stg}	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C

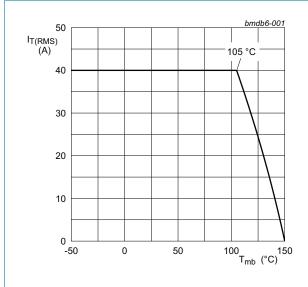
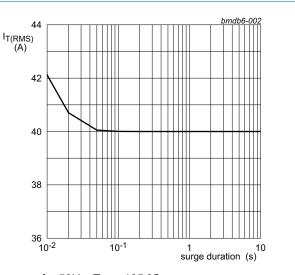


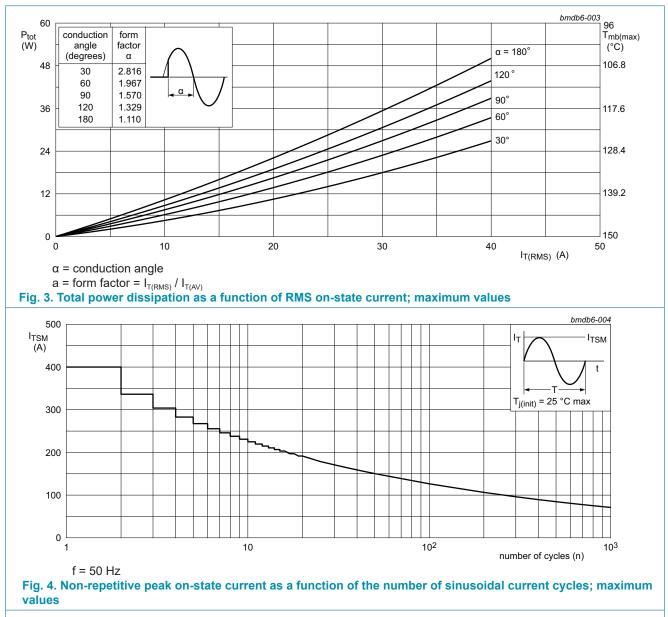
Fig. 1. RMS on-state current as a function of mounting base temperature; maximum values

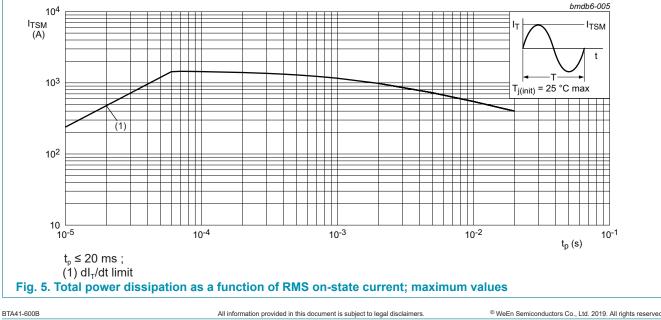




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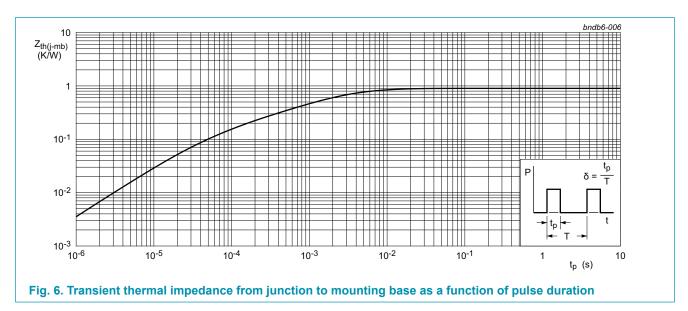
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9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 6	-	-	0.9	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	50	-	K/W



10. Isolation characteristics

Table 6. Isolation characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	from all terminal to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; RH \leq 65 %; T _h = 25 °C		-	-	2500	V

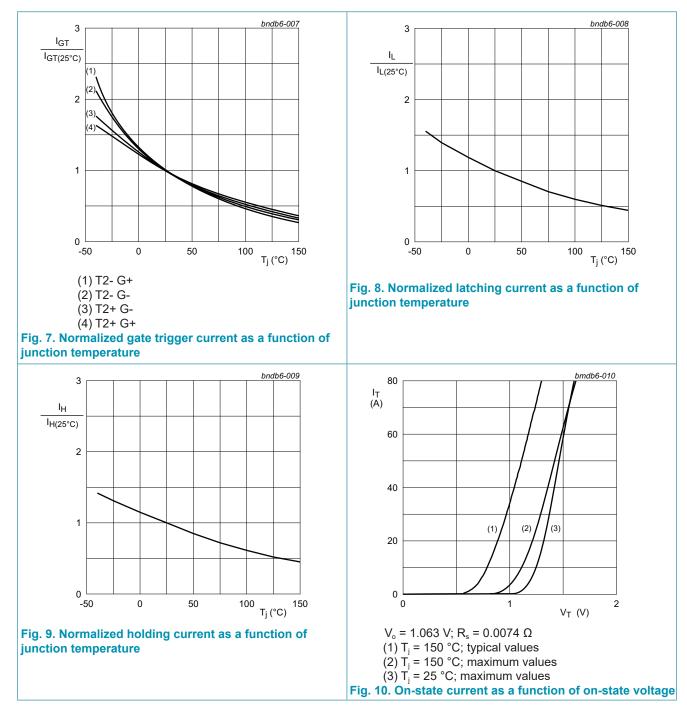
11. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $\text{T}_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	50	mA
		V_{D} = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u>	-	-	50	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G-};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	50	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G+};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	70	mA
l	latching current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 8}$	-	-	100	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2+ G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	160	mA
		V_{D} = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u>	-	-	100	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ T2- G+};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	-	100	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	80	mA
V _T	on-state voltage	I _T = 56.6 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.2	1.5	V
V _{gt}	gate trigger voltage	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; T_{j} = 25 \text{ °C};$ Fig. 11	-	0.8	1.3	V
		V _D = 400 V; I _T = 0.1 A; T _j = 150 °C; Fig. 11	0.2	0.45	-	V
l _D	off-state current	V _D = 600 V; T _j = 25 °C	-	-	10	μA
		V _D = 600 V; T _j = 150 °C	-	-	2.5	mA
Dynamic o	characteristics	· · · · · · · · · · · · · · · · · · ·	· · · · ·			
D	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit$	750	-	-	V/µs
		V_{DM} = 536 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
dI _{com} /dt	rate of change of commutating current		20	-	-	A/ms
		$V_D = 400 \text{ V}; T_j = 150 \text{ °C}; I_{T(RMS)} = 20\text{A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s};$ gate open circuit	10	-	-	A/ms

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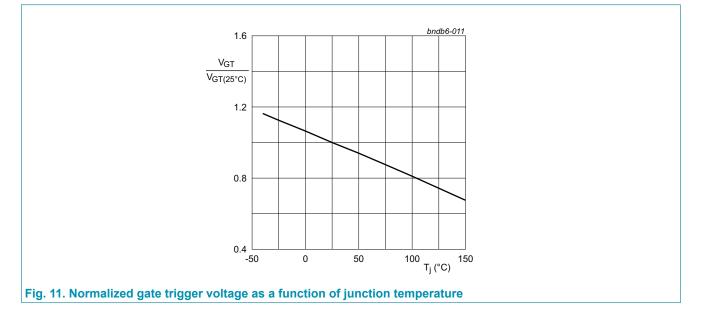
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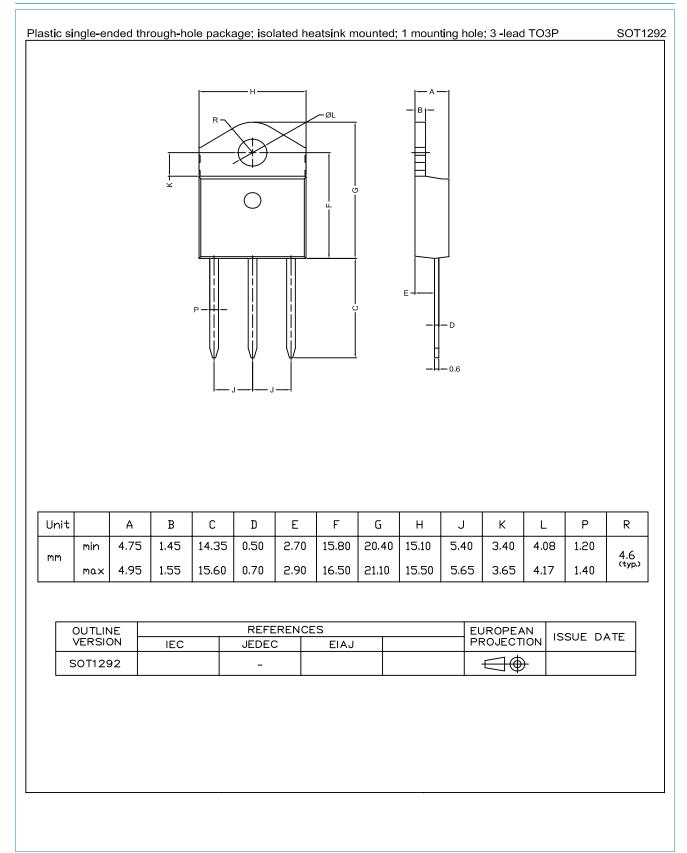
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12. Package outline



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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